

N-Channel 150 V (D-S) MOSFET

PRODUCT SUMMARY

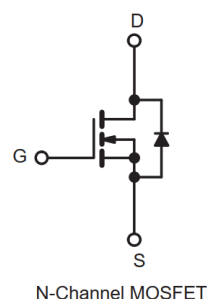
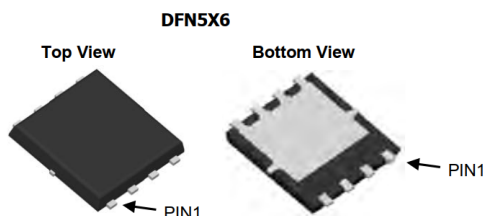
V_{DS} (V)	$R_{DS(on)}$ (m Ω)(Typ.)	I_D (A) ^a	Q_g (Typ.)
150	10 at $V_{GS} = 10$ V	80	45 nC

FEATURES

- DT-Trench Power MOSFET
- 100 % Rg and UIS Tested

APPLICATIONS

- Primary side switch
- DC/DC converters
- Battery and load switch


RoHS
 COMPLIANT


ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C, unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	150	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ($T_J = 150$ °C)	$T_C = 25$ °C	I_D	80
	$T_C = 70$ °C		65
Pulsed Drain Current	I_{DM}	320	A
Single-Pulse Avalanche Energy	E_{AS}	120	mJ
Maximum Power Dissipation	$T_C = 25$ °C	P_D	154
	$T_C = 70$ °C		98.7
	$T_A = 25$ °C		7.5 ^{b,c}
	$T_A = 70$ °C		4.82 ^{b,c}
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^b	R_{thJA}	14	16.6	°C/W
Maximum Junction-to-Case	R_{thJC}	0.6	0.81	

Notes:

a. Based on $T_C = 25$ °C.

b. Surface mounted on 1" x 1" FR4 board.

c. $t = 10$ s.

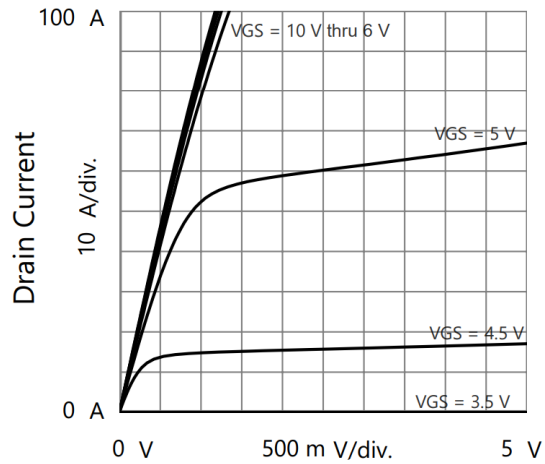
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0, I _D = 250 μA	150			V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	2		4	V
Gate-Source Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 100V, V _{GS} = 0 V			1	μA
		V _{DS} = 100V, V _{GS} = 0 V, T _J = 55 °C			10	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 10 V	80			A
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A		10	13	mΩ
Forward Transconductance ^a	g _{fs}	V _{DS} = 10 V, I _D = 20 A		39		S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		3280		pF
Output Capacitance	C _{oss}			270		
Reverse Transfer Capacitance	C _{rss}			9		
Total Gate Charge	Q _g	V _{DS} = 75 V, V _{GS} = 10 V, I _D = 20 A		45		nC
Gate-Source Charge	Q _{gs}			11.5		
Gate-Drain Charge	Q _{gd}			7.8		
Gate Resistance	R _g	f = 1 MHz		2.5		Ω
Turn-On Delay Time	t _{d(on)}	V _{DD} = 75 V, R _L = 5 Ω I _D ≅ 20 A, V _{GEN} = 10 V, R _g = 1 Ω		12		ns
Rise Time	t _r			5		
Turn-Off DelayTime	t _{d(off)}			21		
Fall Time	t _f			8		
Drain-Source Body Diode Characteristics						
Continous Source-Drain Diode Current	I _S	T _C = 25 °C			80	A
Pulse Diode Forward Current (100 μs)	I _{SM}				320	
Body Diode Voltage	V _{SD}	I _S = 1 A			1.2	V
Body Diode Reverse Recovery Time	t _{rr}	I _F = 20 A, dI/dt = 100 A/μs, T _J = 25 °C		120		ns
Body Diode Reverse Recovery Charge	Q _{rr}			300		nC
Reverse recovery fall time	t _a			52		ns
Reverse recovery rise time	t _b			54		

Notes:

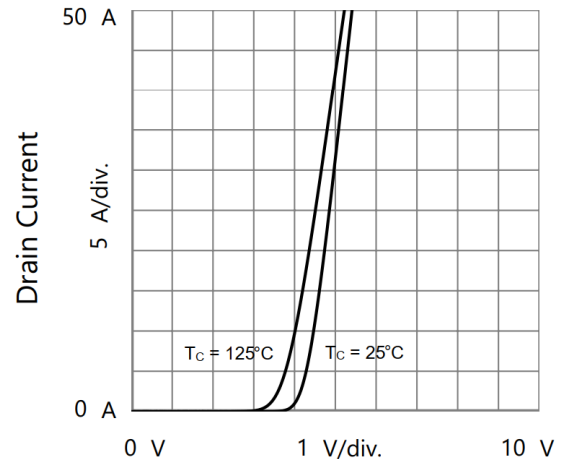
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
 b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

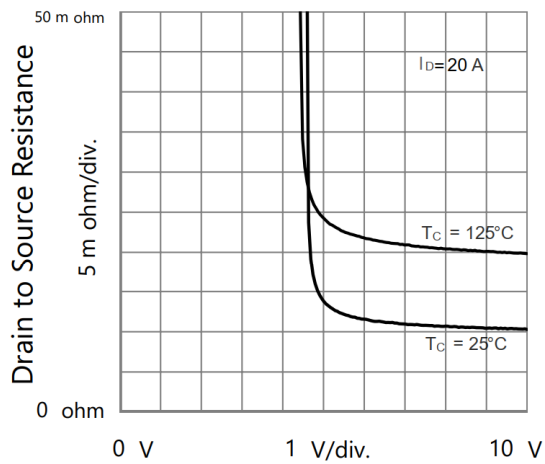
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



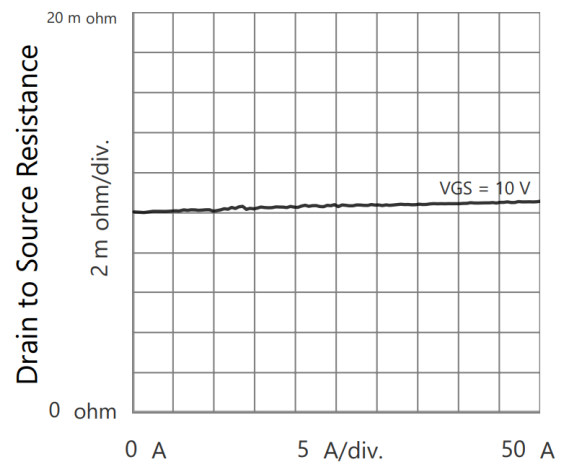
Drain to Source Voltage
Output Characteristics



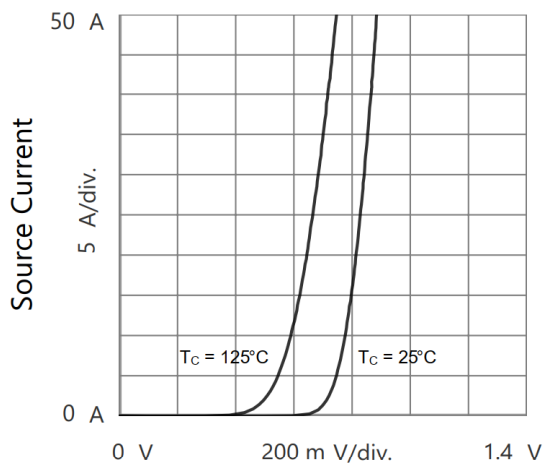
Gate to Source Voltage
Transfer Characteristics



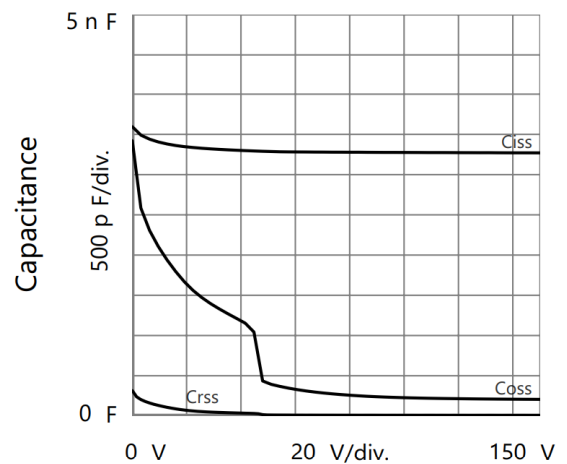
Gate to Source Voltage
Drain to Source Resistance vs. Gate to Source Voltage



Drain Current
Drain to Source Resistance vs. Drain Current

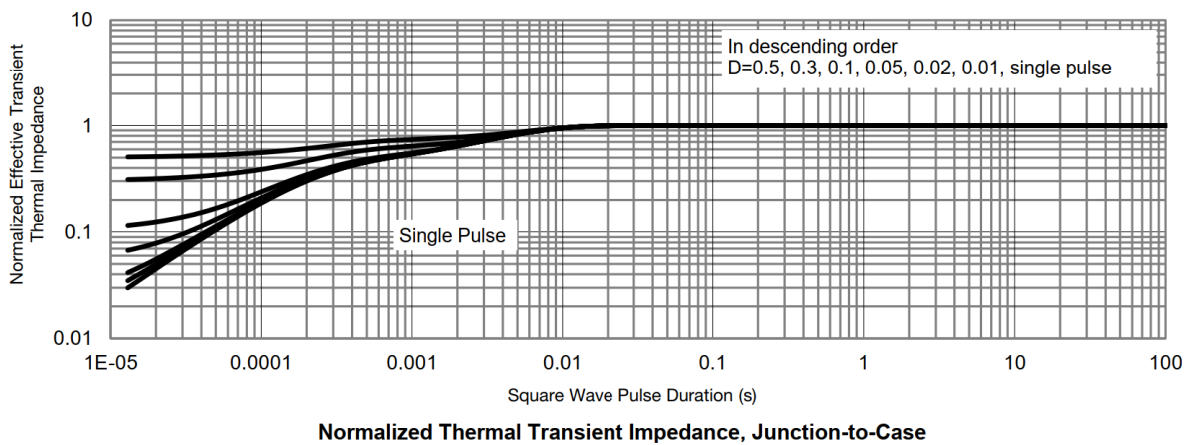
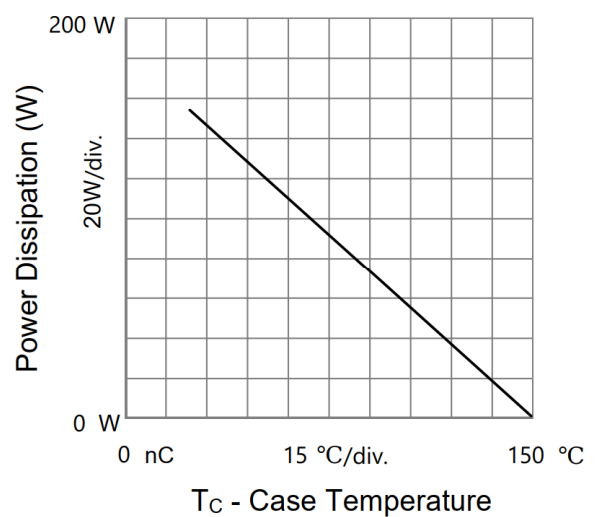
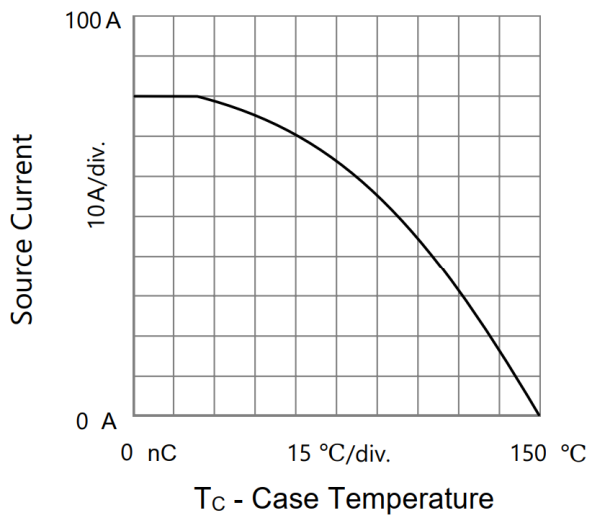
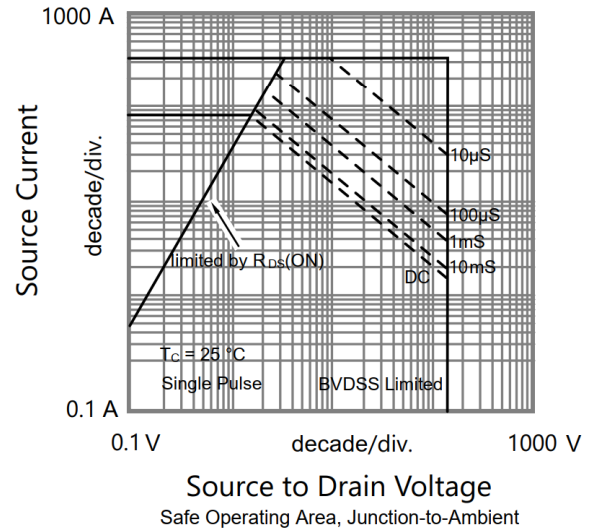
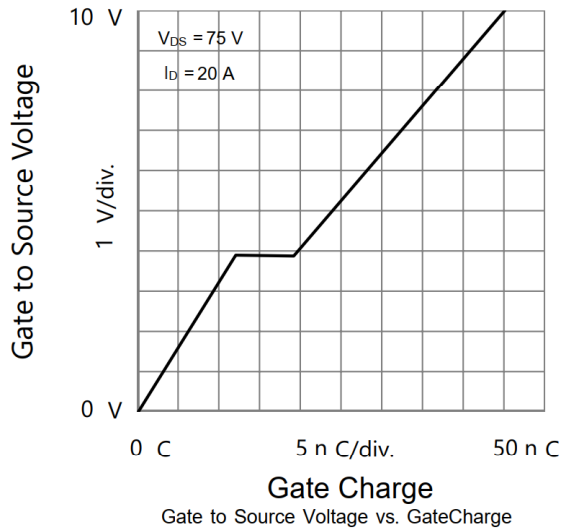


Source to Drain Voltage
Body Diode Forward Characteristics

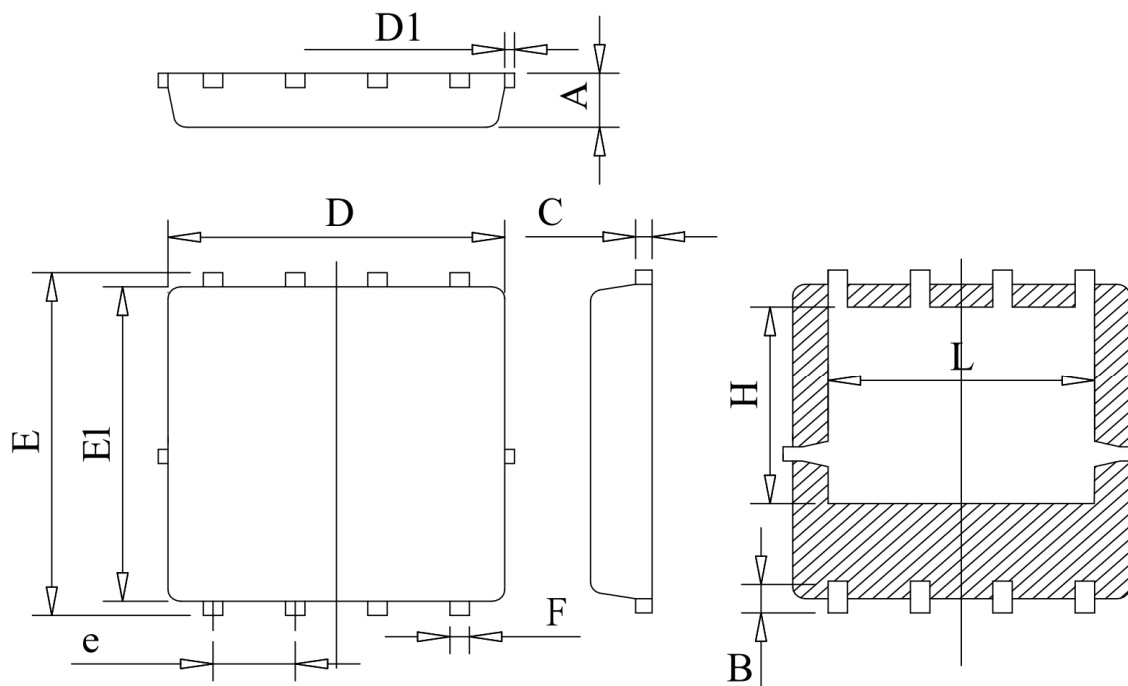


Drain to Source Voltage
Capacitances

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



DFN5X6-8L PACKAGE OUTLINE



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

Unit : mm

Symbol	Min	Typ	Max
A	0.78	0.95	1.12
B	0.45	0.58	0.78
C	0.18	0.254	0.36
D	4.70	5.20	5.45
D1			0.18
E	5.85	6.05	6.25
E1	5.38	5.55	5.98
e	1.15	1.27	1.40
F	0.18	0.30	0.52
H	3.25	3.47	3.70
L	3.75	4.00	4.25

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